

Low Loss Power Switch With Flag

❖ GENERAL DESCRIPTION

AX8714 is a low voltage, single NMOSFET high-side power switch, optimized for self-powered and bus-powered Universal serial bus (USB) application. AX8714 equipped with a charge pump circuitry to drive the internal NMOSFET switch, the switch's low $R_{ds(on)}$ 40mΩ, meets USB voltage droop requirement and a flag output is available to indicate fault conditions to the local USB controller.

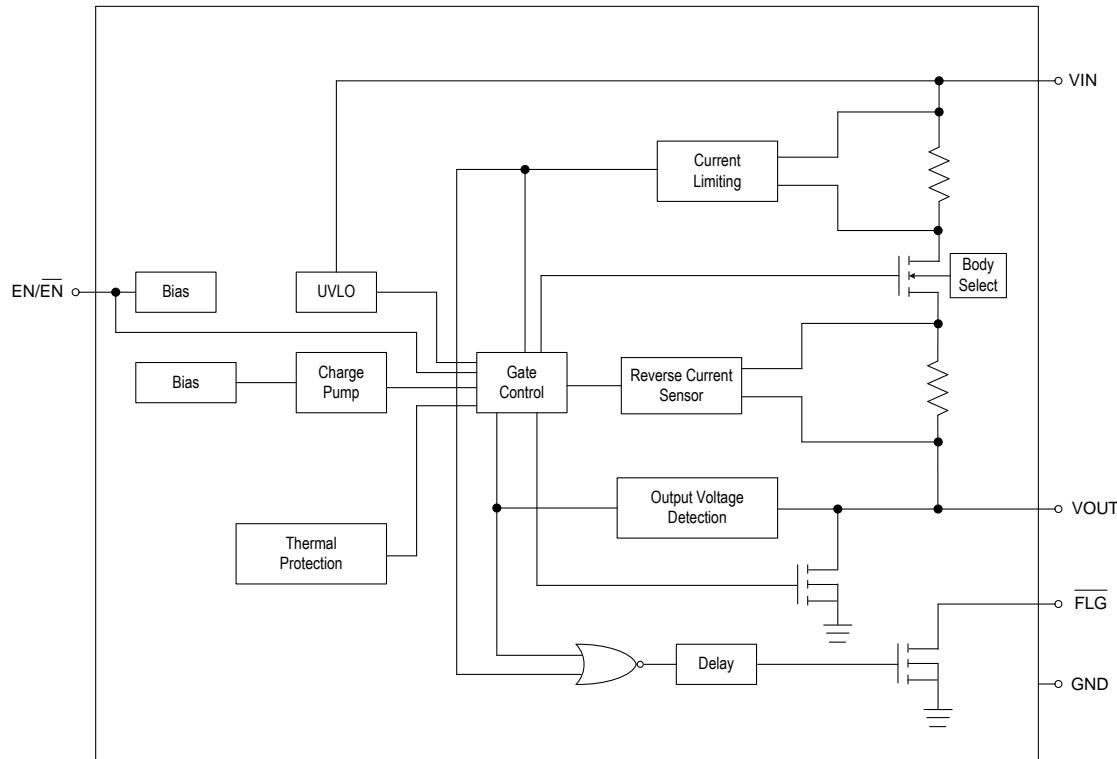
Additional features include soft-start to limit the inrush current during plug-in, thermal shutdown to prevent catastrophic switch failure from high-current loads, under voltage lockout (UVLO) to ensure that the device remains off unless there is a valid input voltage present. The low quiescent current as 35uA makes this device ideal for portable battery operated equipment.

AX8714 is available in TSOT-23-5L, SOT-23-5L, SOP-8L and MSOP-8L packages requiring minimum board space and few peripheral components.

❖ FEATURES

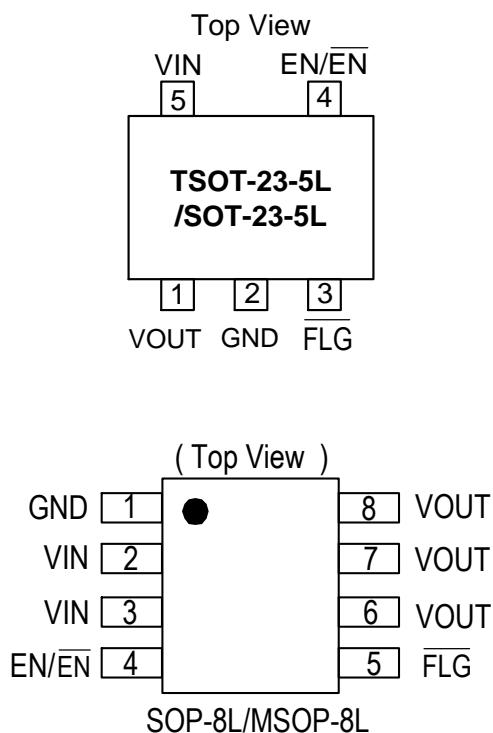
- Wide Input Voltage Range: 2.9V to 5.5V
- Compliant to USB Specifications
- Enable Active Low/High
- Typical $R_{ds(on)}$
40mΩ (TSOT-23-5L)
- Typical 2.1V under voltage lockout
Output can be forced higher than input (Off-state)
- Low supply current
Less than 1uA at the off state
35uA at switch on state
- Open Drain Fault Flag Output
- Hot Plug-In Application(Soft start)
- Current Limiting Protection
- Thermal Shutdown Protection
- Reverse Current Flow Blocking (no body diode)
- RoHS and Halogen Free compliance
- UL Approved-E353665
- TuV EN60950-1 Certification
- CB IEC60950-1 Certification

❖ BLOCK DIAGRAM



❖ PIN ASSIGNMENT

The pin assignment is given by:

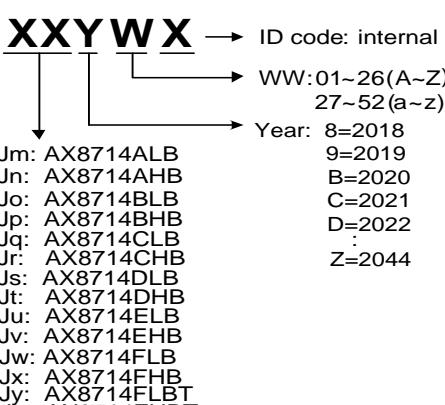
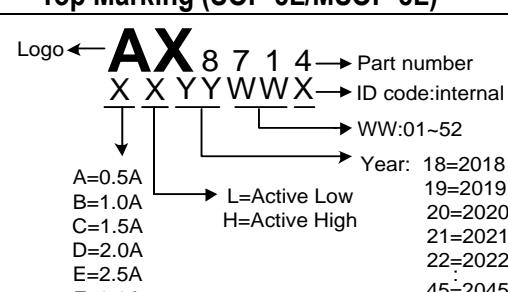


Name	Pin No. TSOT-23-5L /SOT-23-5L	Pin No. SOP-8 /MSOP-8	Description
VOUT	1	6,7,8	Output Voltage.
GND	2	1	Ground.
FLG	3	5	Fault FLAG Output.
EN/EN	4	4	Chip Enable (Active High/Low).
VIN	5	2,3	Power Input Voltage.

❖ Ordering Information

ORDER NUMBER	ENABLE	Current Limit	Package
AX8714ALBA	Active Low	0.5A	SOT-23-5L
AX8714AHBA	Active High	0.5A	SOT-23-5L
AX8714BLBA	Active Low	1.0A	SOT-23-5L
AX8714BHBA	Active High	1.0A	SOT-23-5L
AX8714CLBA	Active Low	1.5A	SOT-23-5L
AX8714CHBA	Active High	1.5A	SOT-23-5L
AX8714DLBA	Active Low	2.0A	SOT-23-5L
AX8714DHBA	Active High	2.0A	SOT-23-5L
AX8714ELBA	Active Low	2.5A	SOT-23-5L
AX8714EHBA	Active High	2.5A	SOT-23-5L
AX8714FLBA	Active Low	3.0A	SOT-23-5L
AX8714FHBA	Active High	3.0A	SOT-23-5L
AX8714FLBTA	Active Low	3.0A	TSOT-23-5L
AX8714FHBTA	Active High	3.0A	TSOT-23-5L
AX8714ALSA	Active Low	0.5A	SOP-8L
AX8714AHSA	Active High	0.5A	SOP-8L
AX8714BLSA	Active Low	1.0A	SOP-8L
AX8714BHSA	Active High	1.0A	SOP-8L
AX8714CLSA	Active Low	1.5A	SOP-8L
AX8714CHSA	Active High	1.5A	SOP-8L
AX8714DLSA	Active Low	2.0A	SOP-8L
AX8714DHSA	Active High	2.0A	SOP-8L
AX8714ELSA	Active Low	2.5A	SOP-8L
AX8714EHSA	Active High	2.5A	SOP-8L
AX8714FLSA	Active Low	3.0A	SOP-8L
AX8714FHSA	Active High	3.0A	SOP-8L
AX8714ALU8A	Active Low	0.5A	MSOP-8L
AX8714AHU8A	Active High	0.5A	MSOP-8L
AX8714BLU8A	Active Low	1.0A	MSOP-8L
AX8714BHU8A	Active High	1.0A	MSOP-8L
AX8714CLU8A	Active Low	1.5A	MSOP-8L
AX8714CHU8A	Active High	1.5A	MSOP-8L
AX8714DLU8A	Active Low	2.0A	MSOP-8L
AX8714DHU8A	Active High	2.0A	MSOP-8L
AX8714ELU8A	Active Low	2.5A	MSOP-8L
AX8714EHU8A	Active High	2.5A	MSOP-8L
AX8714FLU8A	Active Low	3.0A	MSOP-8L
AX8714FHU8A	Active High	3.0A	MSOP-8L

❖ ORDER/MARKING INFORMATION

Top Marking (TSOT-23-5L/SOT-23-5L)	
 Jm: AX8714ALB Jn: AX8714AHB Jo: AX8714BLB Jp: AX8714BHB Jq: AX8714CLB Jr: AX8714CHB Js: AX8714DLB Jt: AX8714DHB Ju: AX8714ELB Jv: AX8714EHB Jw: AX8714FLB Jx: AX8714FHB Jy: AX8714FLBT Jz: AX8714FHBT	
Top Marking (SOP-8L/MSOP-8L)	
 Logo → AX 8 7 1 4 → Part number X X YYWWX → ID code:internal ↓ A=0.5A L=Active Low B=1.0A H=Active High C=1.5A D=2.0A E=2.5A F=3.0A WW:01~52 Year: 18=2018 19=2019 20=2020 21=2021 22=2022 45=2045	

❖ ABSOLUTE MAXIMUM RATINGS

Characteristics	Symbol	Rating	Unit
Supply Input Voltage	V _{IN}	6.5	V
EN Input Voltages and V _{OUT} Voltages		-0.3 to 6.5	V
FLAG Voltage		6.5	V
Package Power Dissipation	P _D	PD=(T _J -T _A) / θ _{JA}	W
Operating Temperature Range		-40 to 85	°C
Junction Temperature	T _J	-40~125	°C
Storage Temperature Range	T _S	-65 to +150	°C
ESD Rating (Note)	HBM (Human Body Mode)	2	kV
	MM (Machine Mode)	200	V
Thermal Resistance from Junction to ambient	SOP-8L	120	°C/W
	TSOT-23-5L	150	
	SOT-23-5L	218	
	MSOP-8L	120	
Thermal Resistance from Junction to case	SOP-8L	60	°C/W
	TSOT-23-5L	35	
	SOT-23-5L	130	
	MSOP-8L	55	

Note: Absolute Maximum Ratings are the values beyond which the life of the device may be impaired.

❖ ELECTRICAL CHARACTERISTICS

(V_{IN}=5V, C_{IN}=1uF, C_{OUT}=10uF per channel, T_A = 25°C, unless otherwise specified)

Characteristics	Symbol	Conditions	Min	Typ	Max	Units		
Input Voltage Range	V _{IN}		2.9	-	5.5	V		
Under Voltage Lockout	V _{UVLO}	V _{IN} Increase	1.7	2.1	2.4	V		
Under Voltage Hysteresis		V _{IN} Decrease	-	100	-	mV		
Input Leakage Current	I _{LEAK}	Disabled, OUT grounded		0.1	1	μA		
Output Leakage Current	AX8714A AX8714B AX8714C	Disabled, R _{LOAD} =0Ω	-	0.5	10	μA		
	AX8714D AX8714E AX8714F							
Reverse Leakage Current	I _{REV}	Disabled, V _{IN} = 0V, V _{OUT} = 5V, I _{REV} at V _{IN}	-	0.1	1	μA		
Switch On Resistance	AX8714A AX8714B AX8714C AX8714D	R _{DSON}	V _{IN} =3.3V, I _{OUT} =0.5A	-	60	75	mΩ	
	AX8714E AX8714F		V _{IN} =5.0V, I _{OUT} =0.5A	-	60	75	mΩ	
	AX8714A AX8714B AX8714C AX8714D		V _{IN} =3.3V, I _{OUT} =0.5A	-	40	50	mΩ	
	AX8714E AX8714F		V _{IN} =5.0V, I _{OUT} =0.5A	-	40	50	mΩ	
Supply Current	AX8714A AX8714B AX8714C AX8714D	I _Q	Switch On, V _{OUT} = OPEN	-	35	55	μA	
	AX8714E AX8714F	I _{SHDN}	Switch Off, V _{OUT} = OPEN	-	0.1	1	μA	
EN Threshold EN Threshold	AX8714A AX8714B AX8714C AX8714D	V _{IL}	Low Voltage	-	-	0.7	V	
	AX8714E AX8714F	V _{IH}	High Voltage	1.3	-	-	V	
EN/EN Input Current	I _{SINK}	V _{EN/EN} From 0V to 5V	-	0.01	-	μA		
Current Limit	AX8714A	I _{LIMIT}	V _{IN} = 5V, V _{OUT} = 4.5V	-40°C ≤ T _A ≤ 85°C	0.6	0.9	1.3	A
	AX8714B		V _{IN} = 5V, V _{OUT} = 4.5V	-40°C ≤ T _A ≤ 85°C	1.1	1.5	1.9	A
	AX8714C		V _{IN} = 5V, V _{OUT} = 4.5V	-40°C ≤ T _A ≤ 85°C	1.6	2.1	2.6	A
	AX8714D		V _{IN} = 5V, V _{OUT} = 4.5V	-40°C ≤ T _A ≤ 85°C	2.2	3.0	3.8	A
	AX8714E		V _{IN} = 5V, V _{OUT} = 4.5V	-40°C ≤ T _A ≤ 85°C	2.7	3.5	4	A

	AX8714F		$V_{IN}=5V$, $V_{OUT}=4.5V$	-40°C ≤ T_A ≤ 85°C	3.2	3.6	4.2	A
Short Circuit Fold back Current Hysteresis		I_{SHORT}	$V_{OUT}=0V$, Measured prior to the thermal shutdown		-	1.2	-	A
Output Turn-on Rise Time	AX8714A	T_R	$V_{IN}=3.3V$, $C_L=1\mu F$, $R_{load}=3\Omega$, V_{OUT} Rise From 10% to 90%		-	1.5	-	ms
	AX8714B		$V_{IN}=5.0V$, $C_L=1\mu F$, $R_{load}=5\Omega$, V_{OUT} Rise From 10% to 90%		-	1.5	-	ms
	AX8714C		$V_{IN}=3.3V$, $C_L=1\mu F$, $R_{load}=3\Omega$, V_{OUT} Rise From 10% to 90%		-	1.6	-	ms
	AX8714D		$V_{IN}=5.0V$, $C_L=1\mu F$, $R_{load}=5\Omega$, V_{OUT} Rise From 10% to 90%		-	3.0	-	ms
Output Turn-on Delay Time	AX8714A	$T_{D(ON)}$	$C_L=1\mu F$, $R_{load}=10\Omega$, EN 10% (\overline{EN} 90%) to V_{OUT} 10%		-	20	-	us
	AX8714B		$C_L=1\mu F$, $R_{load}=10\Omega$, EN 10% (\overline{EN} 90%) to V_{OUT} 10%		-	50	-	us
Output Turn-off Fall Time		T_F	$C_L=1\mu F$, $R_{load}=10\Omega$, V_{OUT} Fall From 90% to 10%		-	20	-	us
Output Turn-off Delay Time		$T_{D(OFF)}$	$C_L=1\mu F$, $R_{load}=10\Omega$, EN 90% (\overline{EN} 10%) to V_{OUT} 90%		-	10	-	us
Reverse Current Limit		I_{RLIMIT}	$V_{IN}=5V$, $V_{OUT}=5.5V$ -40°C ≤ T_A ≤ 85°C			500		mA
Reverse Over Voltage Protect		V_{ROVP}	$V_{OUT} - V_{IN}$			150		mV
Reverse Protect Delay Time		T_{PD}				5		μs

❖ ELECTRICAL CHARACTERISTICS (CONTINUOUS)

($V_{IN}=5V$, $C_{IN}=1\mu F$, $C_{OUT}=10\mu F$, $T_A = 25^\circ C$, unless otherwise specified)

Characteristics	Symbol	Conditions	Min	Typ	Max	Units
FLG Output Resistance	R_{FLG}	$I_{SINK}=1mA$	-	20	40	Ω
FLG Off Current		$V_{\overline{FLG}} = 5V$	-	0.01	1	μA
FLG DELAY TIME	T_{Blank}	From Fault Condition to \overline{FLG} assertion	5	15	20	ms
Output Shutdown Discharge Resistance		Disabled	-	100	150	Ω
Thermal Shutdown Threshold	T_{SD}	Enabled	-	150	-	$^\circ C$
Thermal Shutdown Hysteresis	T_{HYS}	$V_{OUT} = 0V$	-	20	-	$^\circ C$

Note 1: Thermal Resistance is specified with approximately 1 square of 1 oz copper.

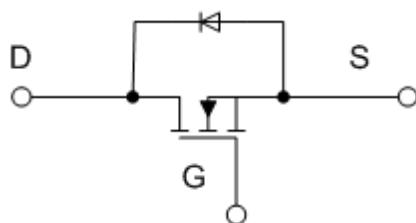
Note 2: 100% production test at $+25^\circ C$. Specifications over the temperature range are guaranteed by design and characterization. The device is not guaranteed to function outside its operating conditions.

❖ APPLICATION INFORMATION

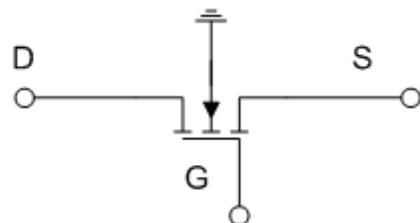
The AX8714 is a single N-MOSFET high-side power switch with enable input, optimized for self-powered and bus-powered Universal Serial Bus (USB) applications. The AX8714 series are equipped with a charge pump circuitry to drive the internal N-MOSFET switch; The switch's low $R_{ds(on)}$, $40m\Omega$ meets USB voltage drop requirements and a flag output is available to indicate fault conditions to the local USB controller.

Input and Output

V_{IN} (Input) is the power source connection to the internal circuitry and the drain of the N-MOSFET. V_{OUT} (Output) is the source of the N-MOSFET. In a typical application, current flows through the switch from V_{IN} to V_{OUT} toward the load. If V_{OUT} is greater than V_{IN} , current will flow from V_{OUT} to V_{IN} since the MOSFET is bidirectional when on. Unlike a normal MOSFET, there is no a parasitic body diode between drain and source of the MOSFET, the AX8714 prevents reverse current flow if V_{OUT} being externally forced to a higher voltage than V_{IN} when the output disabled ($V_{EN} < 0.8V$ or $V_{EN} > 2V$).



Normal MOSFET



AX8714

Enable

The switch will be disabled when the EN pin is low or \overline{EN} is high. During this condition, the internal circuitry and MOSFET are all turned off and the supply current reduces to 0.1uA typically. Floating the \overline{EN} may cause unpredictable operation. EN should not be allowed to be negative to GND. The EN/ \overline{EN} pin may be directly tied to VIN (GND) to keep the part on.

UVLO

Under-Voltage Lockout (UVLO) prevents the power MOSFET from turning on until the input voltage is up to approximately 2.1V. If the input voltage drops below about 2.0V, UVLO turns off the power MOSFET switch and \overline{FLG} will be asserted accordingly. Under voltage protection is function when the part is enabled.

Soft Start for Hot Plug Application

In order to eliminate the upstream voltage droop caused by the large inrush current during the hot plug events, the soft start feature effectively isolates the power source from extremely large load capacitor, satisfying the USB voltage droop requirement.

Fault Flag

The AX8714 series provides a \overline{FLG} signal pin which is an N-Channel open drain MOSFET output. This open drain output goes low when $V_{OUT} < V_{IN} - 1V$, current limit or the die temperature exceeds 150°C approximately. The \overline{FLG} output is typically about 200mV when sinking a 10mA load. A 100K pull up resistor is required at the \overline{FLG} pin. \overline{FLG} Pin will be asserted at the over-current condition after the flag response delay time TD. This ensures that \overline{FLG} is asserted only at the valid over-current conditions and error reporting is eliminated.

Current Limiting and Short-Circuit Protection

The current limit circuitry prevents damage to the MOSFET switch and the hub downstream port but can deliver load current up to the current limit threshold of typically 3.2A through the switch of AX8714. When a heavy load or short circuit is applied to an enabled switch, a large transient current may flow until the current limit circuitry responds. Once this current limit threshold is exceeded the device enters constant current mode until the thermal shutdown occurs or the fault is removed.

Thermal Shutdown

Thermal shutdown is employed to protect the device from damage if the die temperature exceeds approximately 150°C. If enabled, the switch automatically restarts when the die temperature falls 20°C. The output and \overline{FLG} signal will continue to cycle on and off until the device is disabled or the fault is removed.

Reverse Current Limit & Reverse over Voltage Protect

The AX8714 series provides the reverse current limit(Rlimit) function to clamp the current through MOSFET switch from output side to the input side when output(Vout) is higher than input(V_{IN}) which is caused by external wrong connects. If $0V < (Vout - Vin) < 150mV$ (typically), the reverse current through the MOSFET switch could be limited to 500mA(typically) until the wrong connects be removed or $(Vout - Vin) > 150mV$.

In addition to Rlimit, the reverse over voltage protect(Rovp) function also be added in the AX8714 series, this function cut off any path from output side to input side and automatic recovery when fault issue be removed.

Input capacitor

A 1uF low ESR ceramic capacitor from V_{IN} to GND, located at the device is strongly recommended to prevent the input voltage drooping during hot-plug events. However, higher capacitor values will further reduce the voltage droop at the input. Furthermore, without the bypass capacitor, an output short may cause sufficient ringing on the input (from source lead inductance) to destroy the internal control circuitry. The input transient must not exceed 6.5V of the absolute maximum supply voltage even for a short duration.

Output capacitor

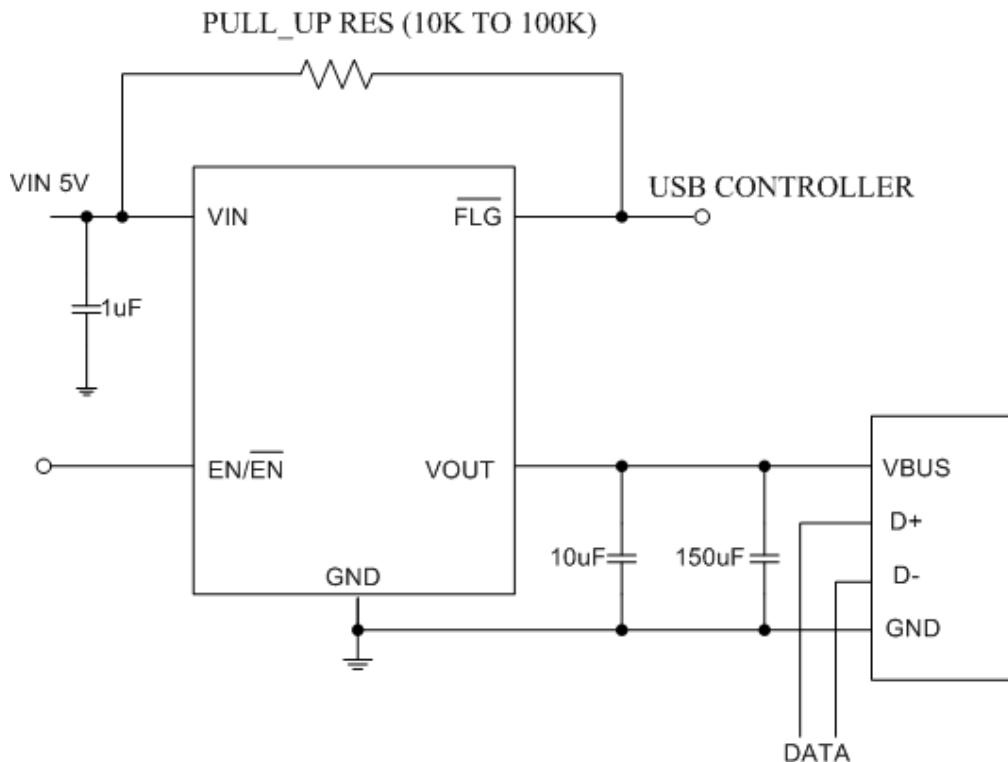
A low ESR 150uF aluminum electrolytic or tantalum between V_{OUT} and GND is strongly recommended to meet the 330mV maximum droop requirement in the hub VBUS (Per USB 2.0, output ports must have a minimum 120uF of low ESR bulk capacitor per hub). Standard bypass methods should be used to minimize inductance and resistance between the bypass capacitor and the downstream connector to reduce EMI and decouple voltage droop caused when downstream cables are hot insertion transients. Ferrite beads in series with VBUS, the ground line and the 0.1uF bypass capacitors at the power connector pins are recommended for EMI and ESD protection. The bypass capacitor itself should have a low dissipation factor to allow decoupling at higher frequencies.

PCB Layout Guide

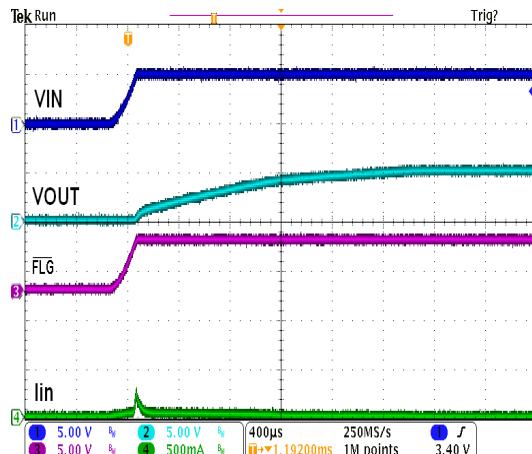
For best performance of the AX8714 series, the following guidelines must be strictly followed:

1. Input and output capacitors should be placed close to the IC and connected to ground plane to reduce noise coupling.
2. The GND should be connected to a strong ground plane for heat sink.
3. Keep the main current traces as possible as short and wide.

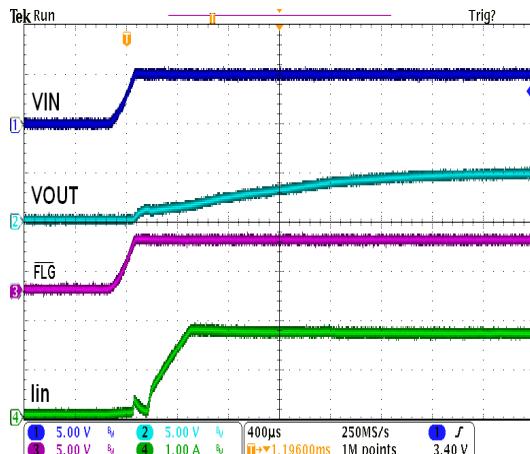
❖ APPLICATION CIRCUIT



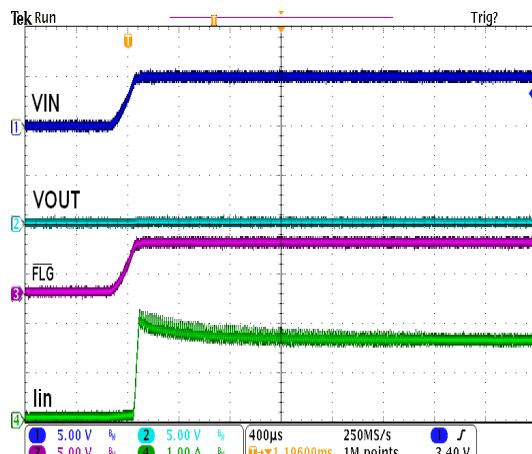
❖ TYPICAL CHARACTERISTICS



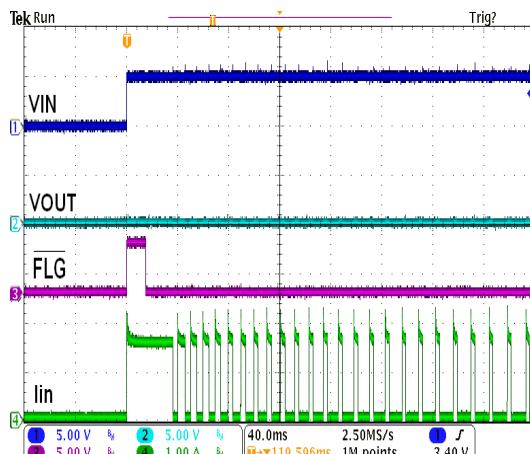
No load power on



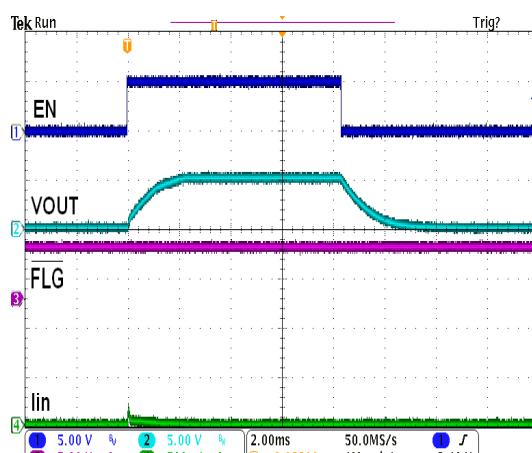
1.7A load power on



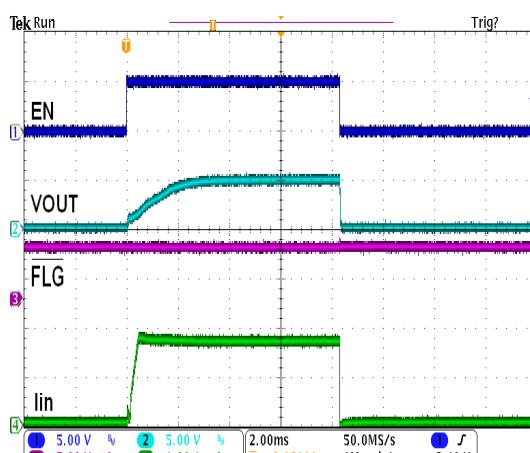
Output short circuit power on



output short circuit & over temperature protection

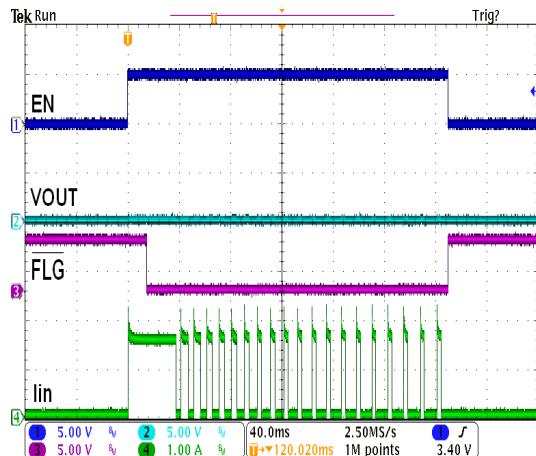


No load enable on/off

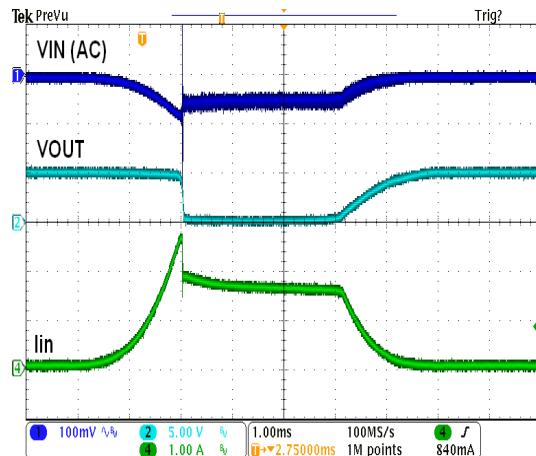


1.7A load enable on/off

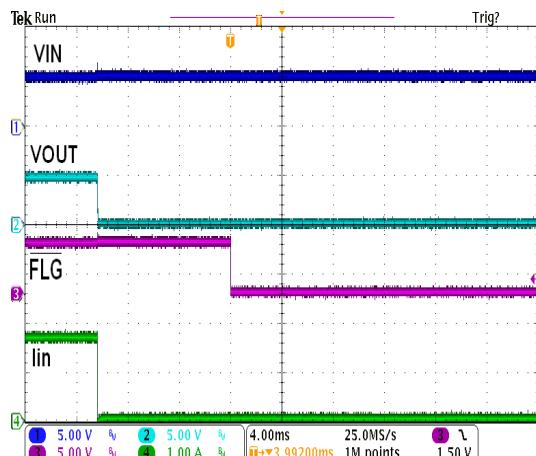
❖ TYPICAL CHARACTERISTICS (CONTINUOUS)



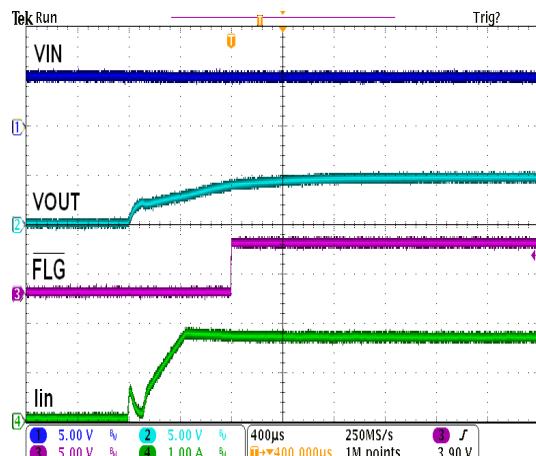
Output short circuit enable on/off



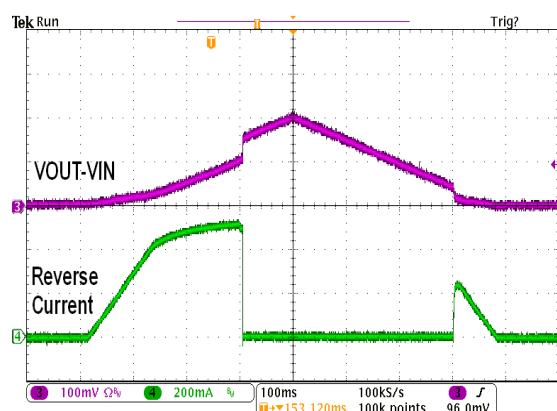
over current & short circuit protection



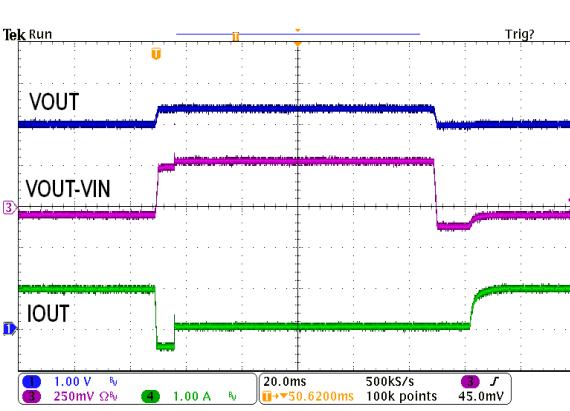
1.7A load thermal shutdown



1.7A load thermal shutdown release



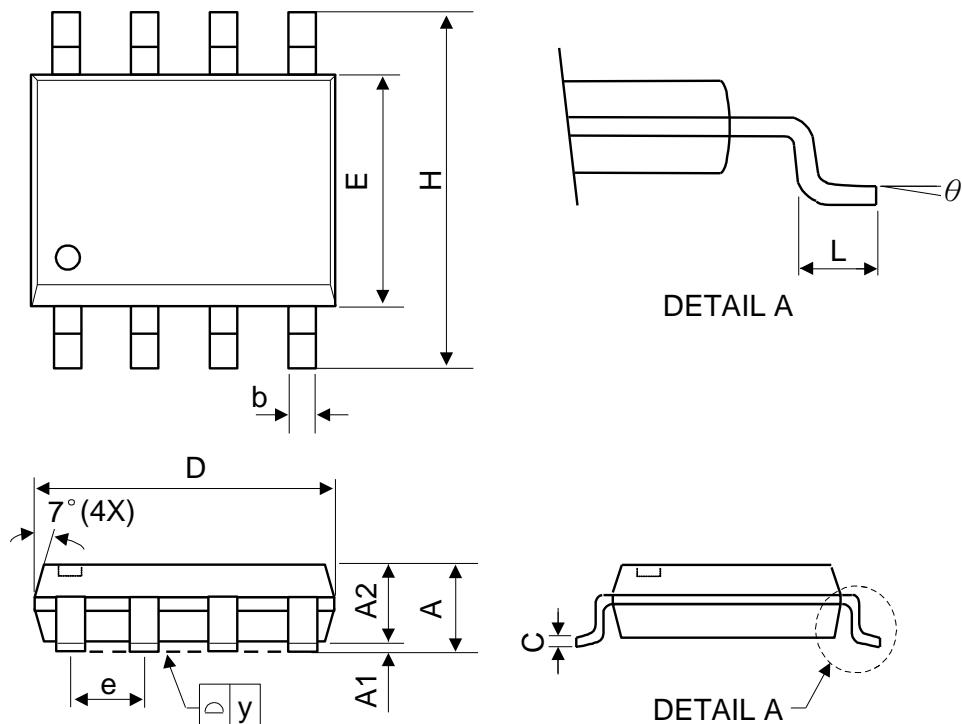
Reverse current protection



Reverse current protection

❖ PACKAGE OUTLINES

(1) SOP-8L

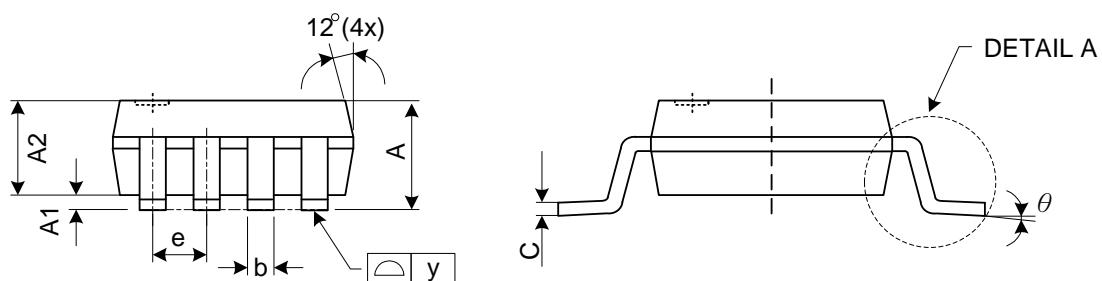
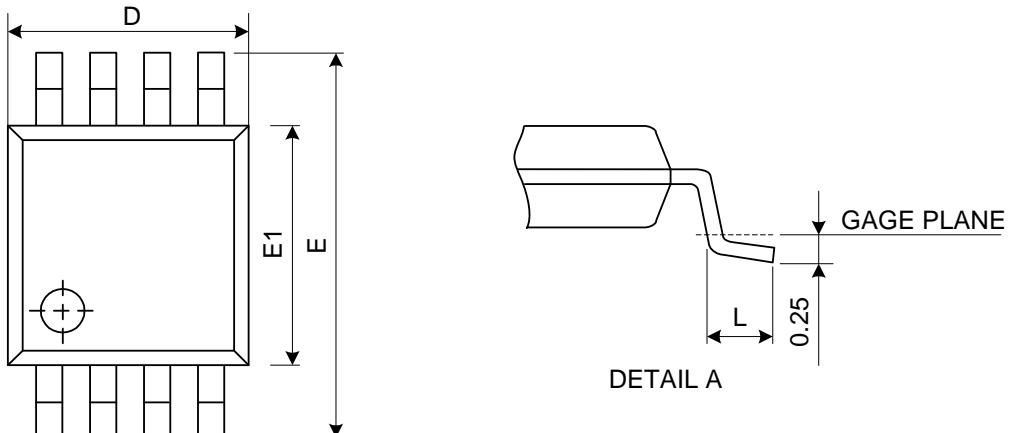


Symbol	Dimensions in Millimeters			Dimensions in Inches		
	Min.	Nom.	Max.	Min.	Nom.	Max.
A	-	-	1.75	-	-	0.069
A1	0.1	-	0.25	0.04	-	0.1
A2	1.25	-	-	0.049	-	-
C	0.1	0.2	0.25	0.0075	0.008	0.01
D	4.7	4.9	5.1	0.185	0.193	0.2
E	3.7	3.9	4.1	0.146	0.154	0.161
H	5.8	6	6.2	0.228	0.236	0.244
L	0.4	-	1.27	0.015	-	0.05
b	0.31	0.41	0.51	0.012	0.016	0.02
e	1.27 BSC			0.050 BSC		
y	-	-	0.1	-	-	0.004
θ	0°	-	8°	0°	-	8°

Mold flash shall not exceed 0.25mm per side

JEDEC outline: MS-012 AA

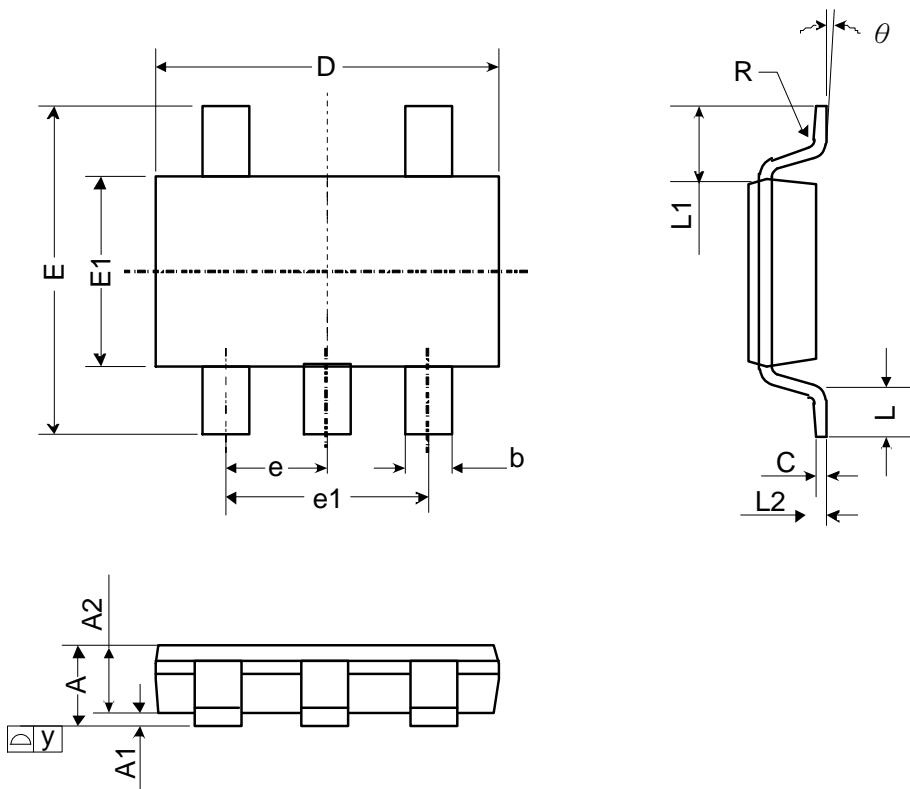
(2) MSOP-8L



Symbol	Dimensions in Millimeters			Dimensions in Inches		
	Min.	Nom.	Max.	Min.	Nom.	Max.
A	-	-	1.10	-	-	0.043
A1	0.00	0.08	0.15	0.000	0.003	0.006
A2	0.75	0.85	0.95	0.030	0.033	0.037
b	0.22	0.30	0.38	0.009	0.012	0.015
C	0.08	0.15	0.23	0.003	0.006	0.009
D	2.90	3.00	3.10	0.114	0.118	0.122
E	4.80	4.90	5.00	0.189	0.193	0.197
E1	2.90	3.00	3.10	0.114	0.118	0.122
e	0.65 BSC			0.026 BSC		
L	0.40	0.60	0.80	0.016	0.024	0.031
y	-	-	0.1	-	-	0.004
θ	0°	4°	8°	0°	4°	8°

JEDEC outline: MO-187 AA

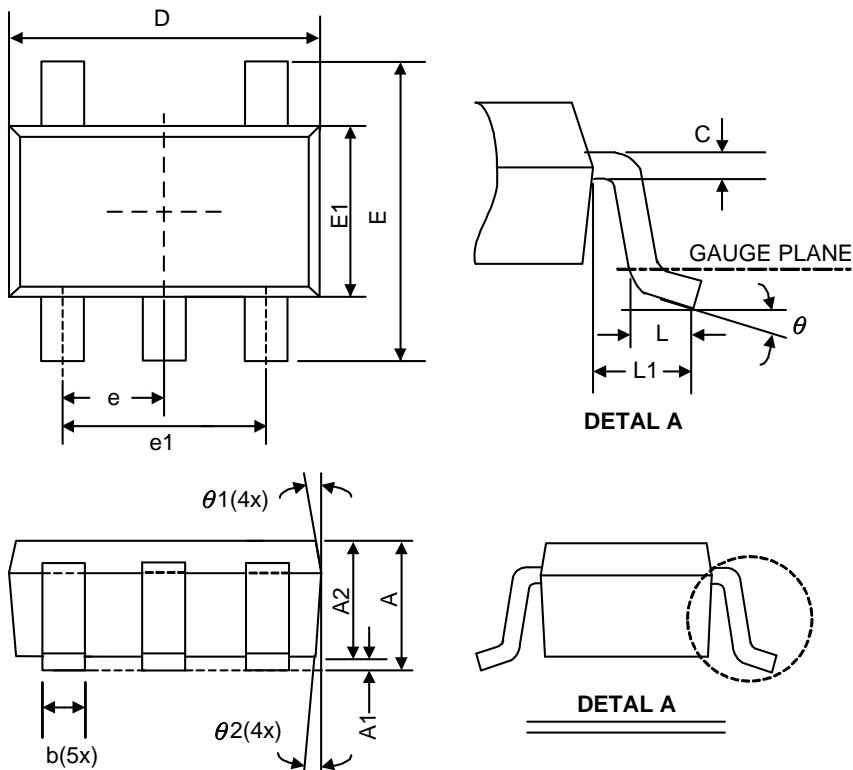
(3) TSOT-23-5L



Symbol	Dimensions in Millimeters			Dimensions in Inches		
	Min.	Nom.	Max.	Min.	Nom.	Max.
A	-	-	1.1	-	-	0.043
A1	0	-	0.1	0	-	0.004
A2	0.7	0.9	1	0.028	0.035	0.039
b	0.3	0.4	0.5	0.012	0.016	0.02
C	0.08	0.14	0.2	0.003	0.006	0.008
D	2.7	2.9	3.1	0.11	0.114	0.118
E	2.6	2.8	3	0.102	0.11	0.118
E1	1.5	1.6	1.7	0.059	0.063	0.067
e	0.95 BSC.			0.037 BSC.		
e1	1.90 BSC.			0.075 BSC.		
L	0.3	0.45	0.6	0.012	0.018	0.024
L1	0.60 REF.			0.024 REF.		
L2	0.25 BSC.			0.010 BSC.		
y	-	-	0.1	-	-	0.004
R	0.1	-	-	0.004	-	-
θ	0°	-	8°	0°	-	8°

JECED outline: MO-193 AB

(4) SOT-23-5L

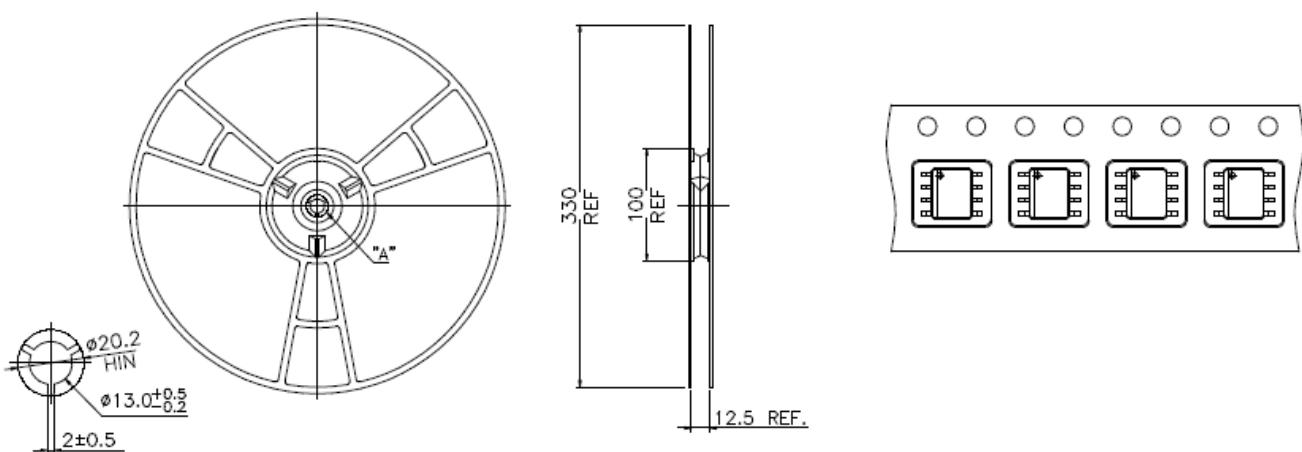
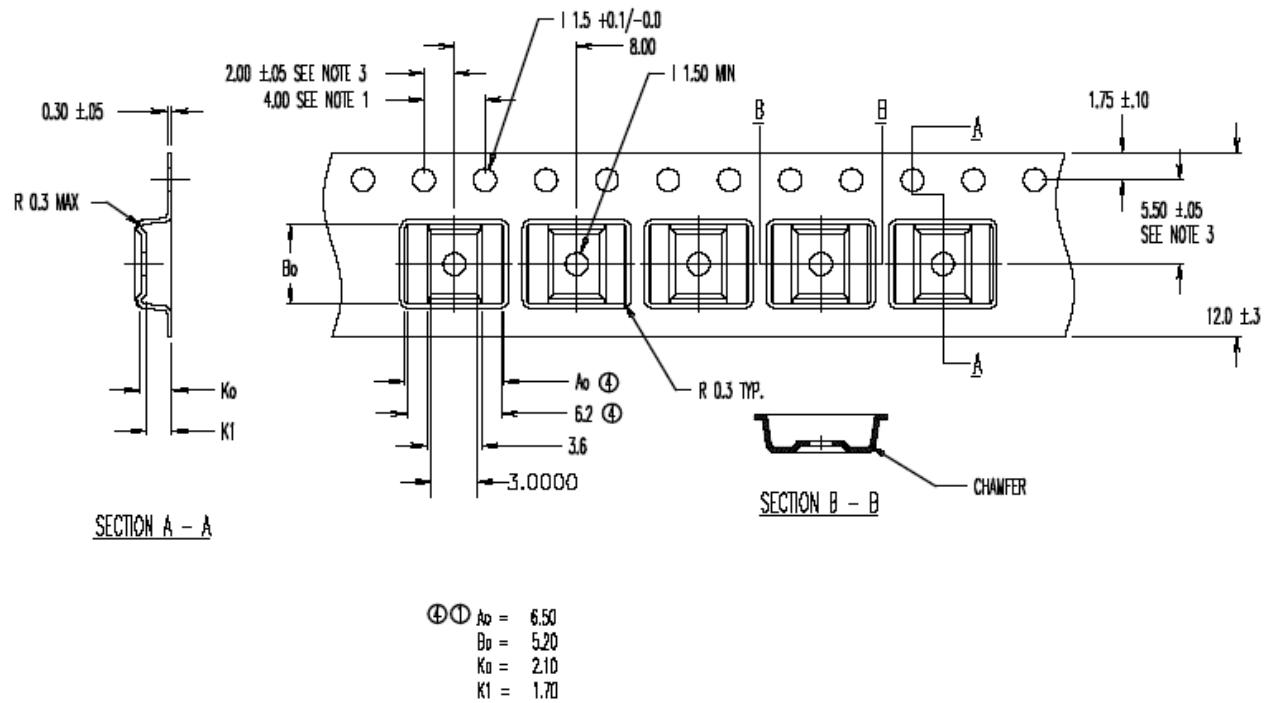


Symbol	Dimensions in Millimeters			Dimensions in Inches		
	Min.	Nom.	Max.	Min.	Nom.	Max.
A	-	-	1.45	-	-	0.057
A1	0	0.08	0.15	0	0.003	0.006
A2	0.9	1.1	1.3	0.035	0.043	0.051
b	0.3	0.4	0.5	0.012	0.016	0.02
C	0.08	0.15	0.22	0.003	0.006	0.009
D	2.7	2.9	3.1	0.106	0.114	0.122
E1	1.4	1.6	1.8	0.055	0.063	0.071
E	2.6	2.8	3	0.102	0.11	0.118
L	0.3	0.45	0.6	0.012	0.018	0.024
L1	0.5	0.6	0.7	0.02	0.024	0.028
e1	1.9 BSC			0.075 BSC		
e	0.95 BSC			0.037 BSC		
θ	0°	4°	8°	0°	4°	8°
θ 1	5°	10°	15°	5°	10°	15°
θ 2	5°	10°	15°	5°	10°	15°

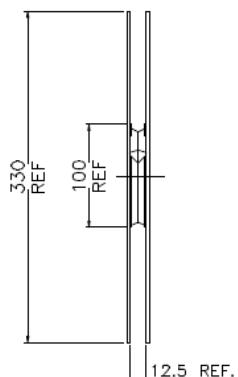
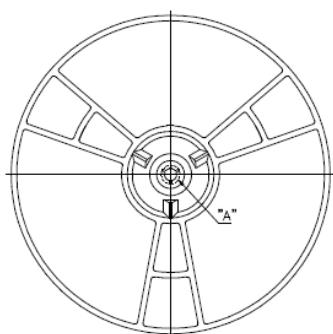
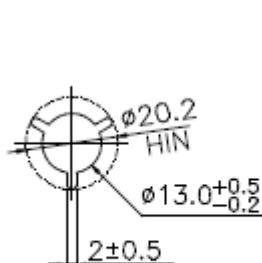
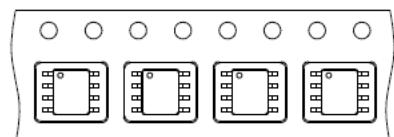
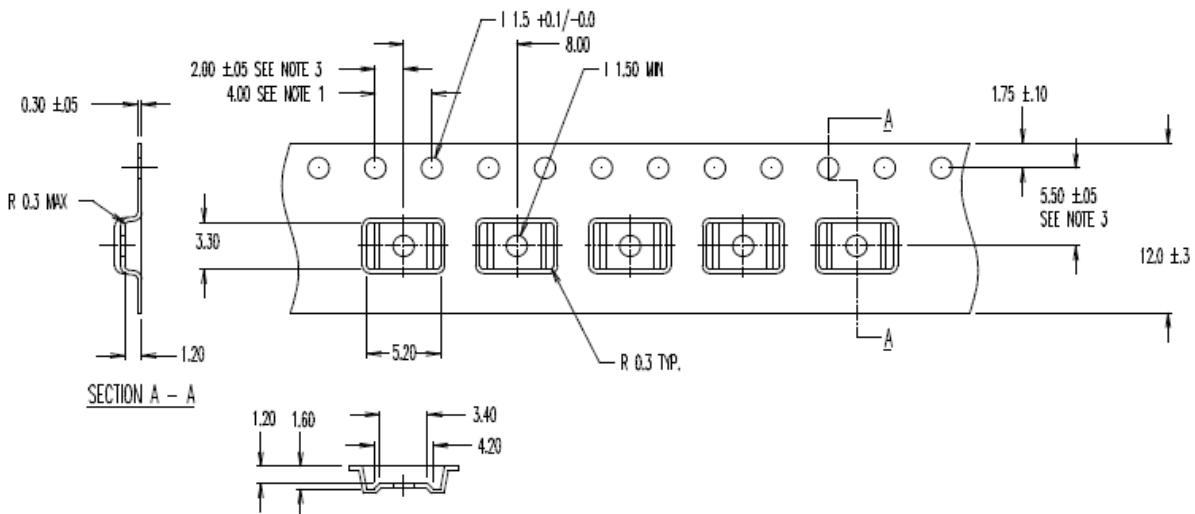
JEDEC outline: MO-178 AA

❖ CARRIER TAPE DIMENSION

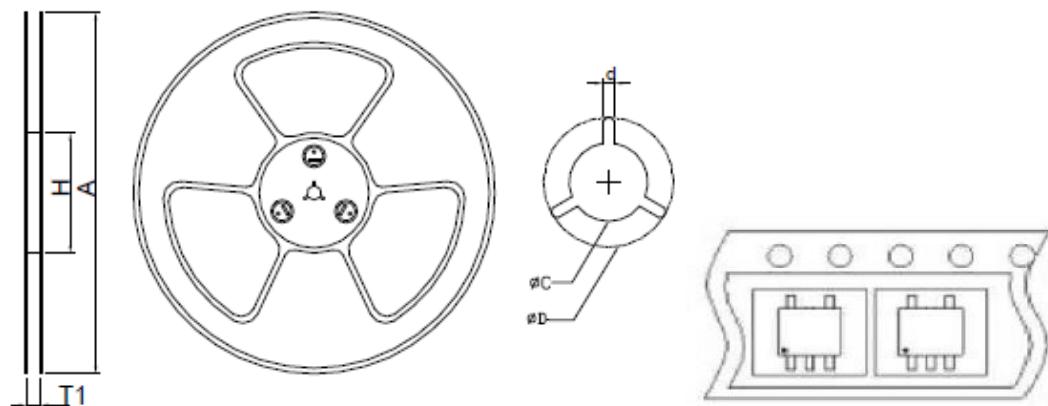
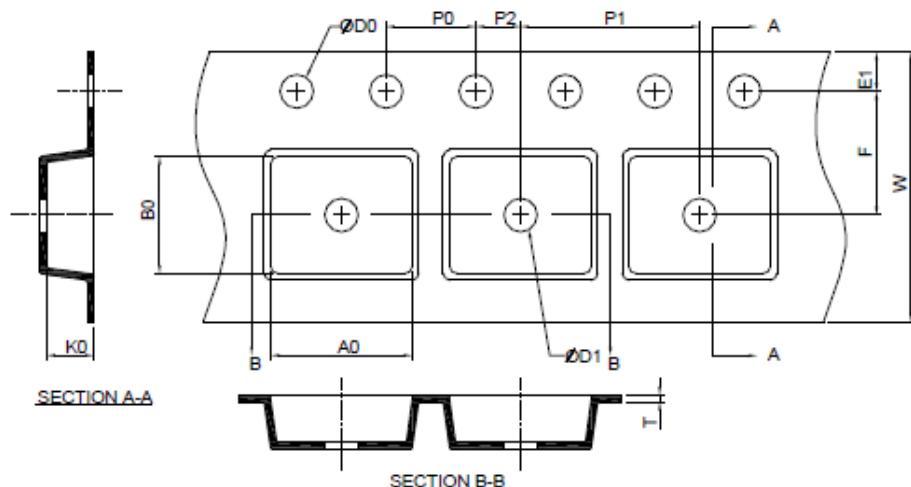
(1) SOP-8L



(2) MSOP-8L



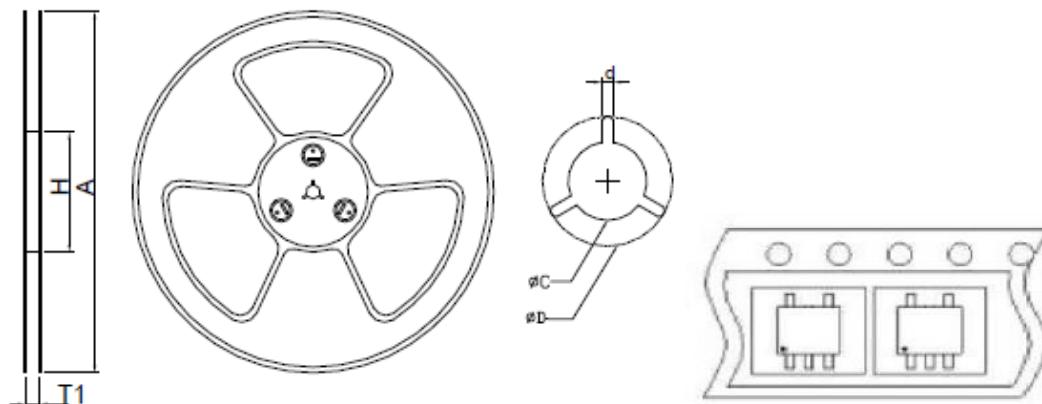
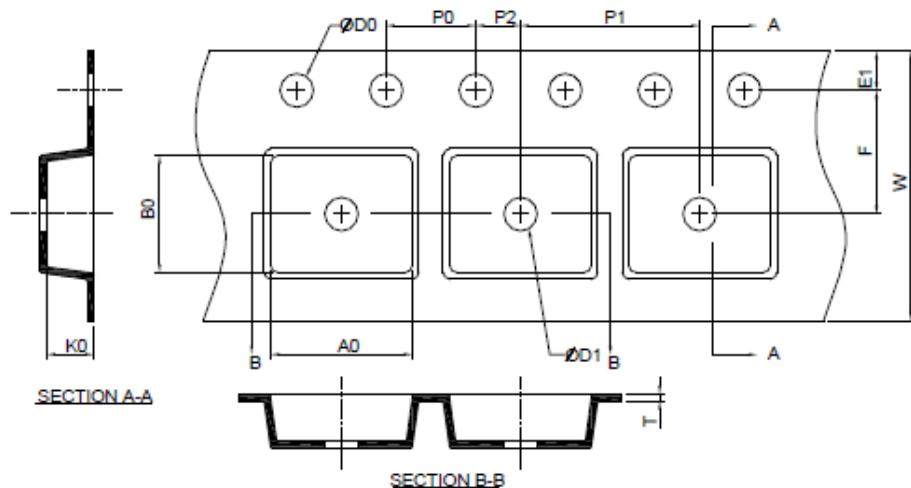
(3) TSOT-23-5L



A	H	T1	C	d	D	W	E1	F
178.0 ± 2.00	50 MIN.	$8.4 + 2.00$ -0.00	$13.0 + 0.50$ -0.20	1.5 MIN.	20.2 MIN.	8.0 ± 0.30	1.75 ± 0.10	3.5 ± 0.05
P0	P1	P2	D0	D1	T	A0	B0	K0
4.0 ± 0.10	4.0 ± 0.10	2.0 ± 0.05	$1.5 + 0.10$ -0.00	1.0 MIN.	$0.6 + 0.00$ -0.40	3.20 ± 0.20	3.10 ± 0.20	1.50 ± 0.20

(mm)

(4) SOT-23-5L



A	H	T1	C	d	D	W	E1	F
178.0 ± 2.00	50 MIN.	$8.4 + 2.00$ -0.00	$13.0 + 0.50$ -0.20	1.5 MIN.	20.2 MIN.	8.0 ± 0.30	1.75 ± 0.10	3.5 ± 0.05
P0	P1	P2	D0	D1	T	A0	B0	K0
4.0 ± 0.10	4.0 ± 0.10	2.0 ± 0.05	$1.5 + 0.10$ -0.00	1.0 MIN.	$0.6 + 0.00$ -0.40	3.20 ± 0.20	3.10 ± 0.20	1.50 ± 0.20

(mm)